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Electron beam induced current study of minority carrier diffusion length in homoepitaxial GaN



San Diego, CA
August 30, 2016

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Application space for GaN in power electronics

high power • high temperature • high frequency • low power losses • low weight and volume

Data Centers



gizmodo.com

Aerospace



nasa.gov

Energy



ge.com

solarcity.com

energy.gov

Transportation



tesla.com

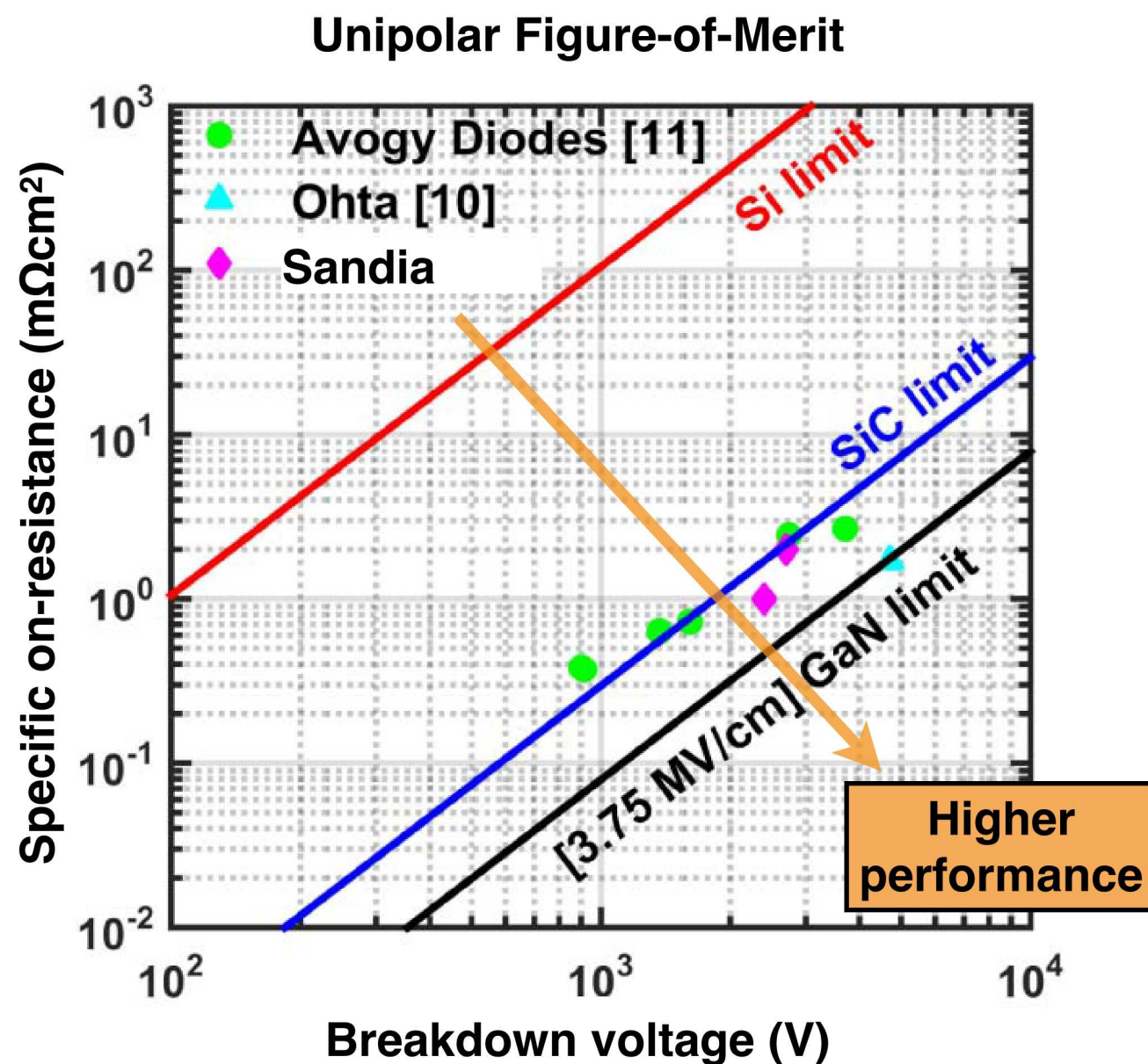
Consumer Electronics



apple.com

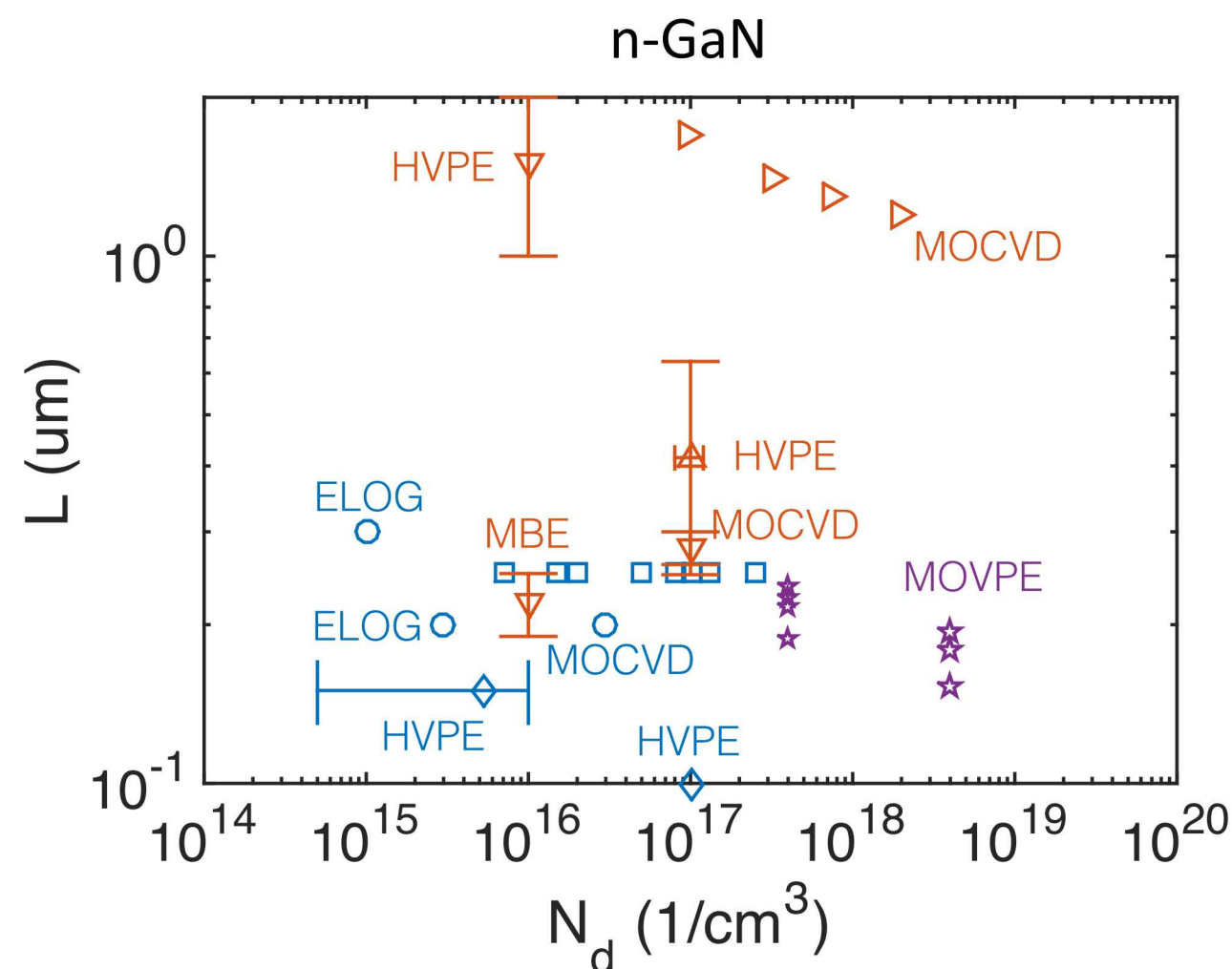
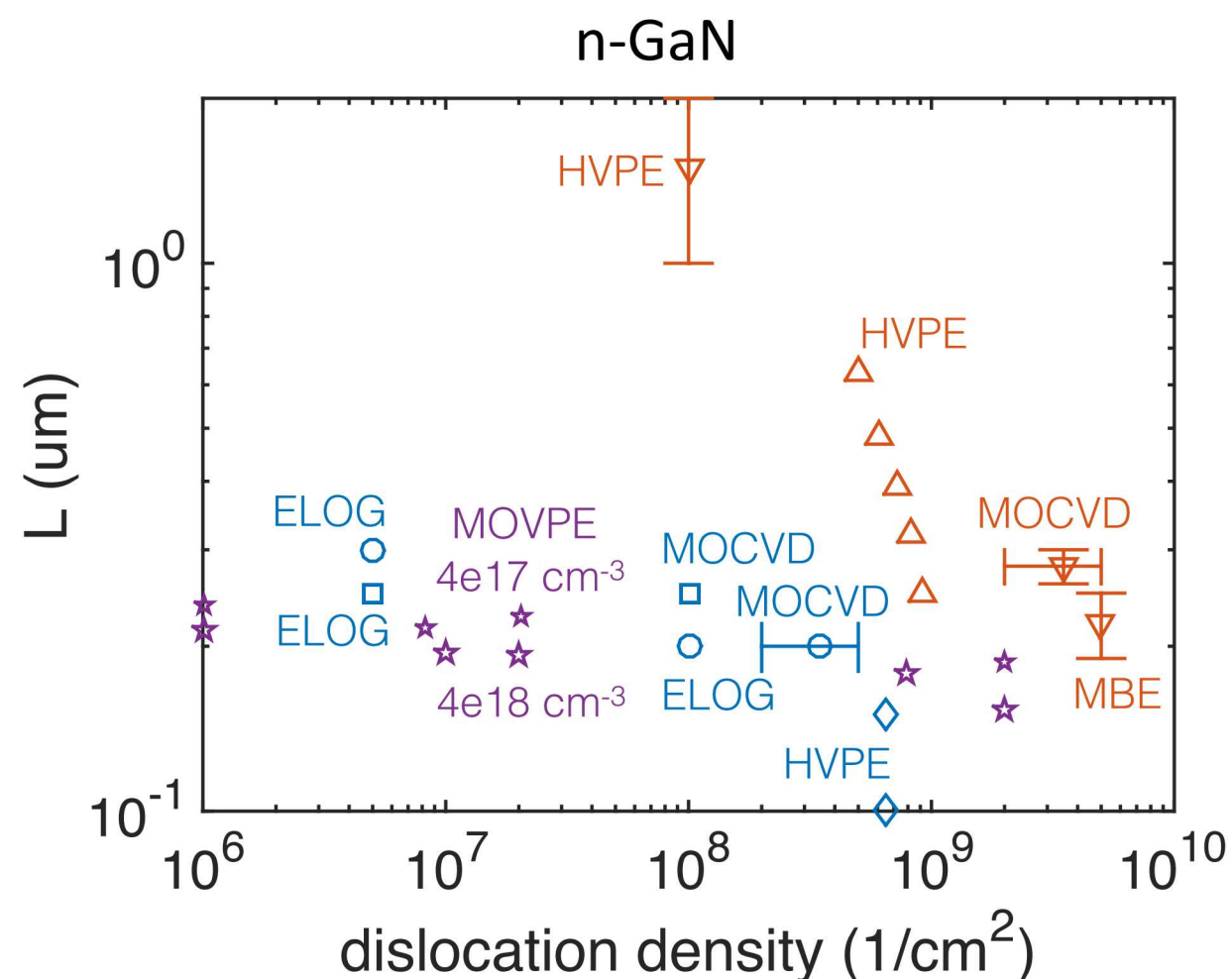
Understanding minority carrier diffusion length is important for improving device performance

State-of-the-art devices do not achieve the theoretical limits of performance



Dickerson et al., IEEE Trans. 63, (2016)

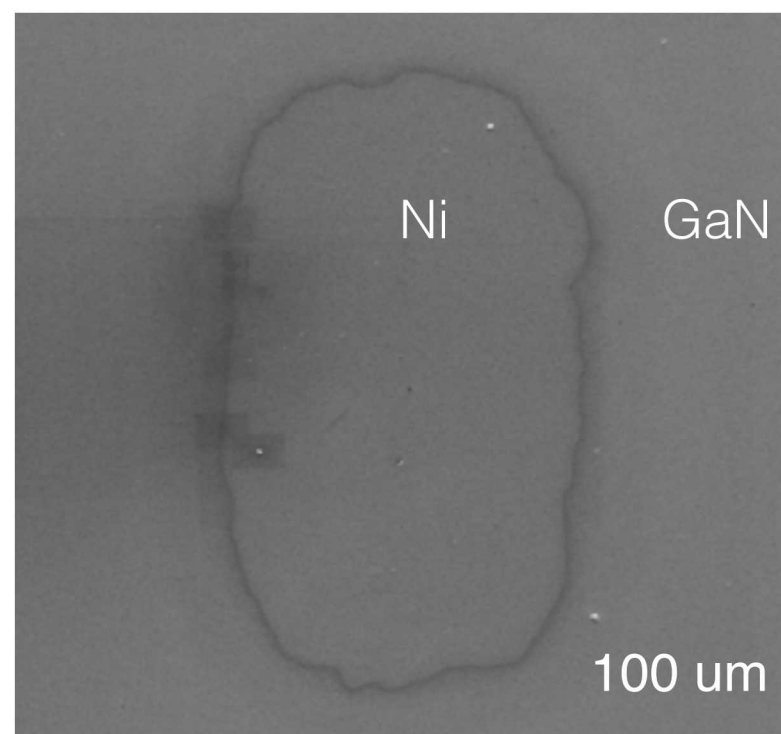
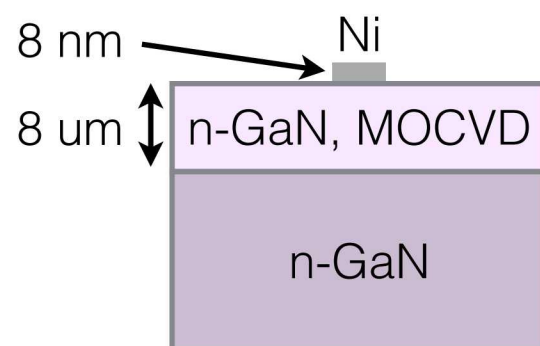
Literature reports of GaN diffusion length, L , vary



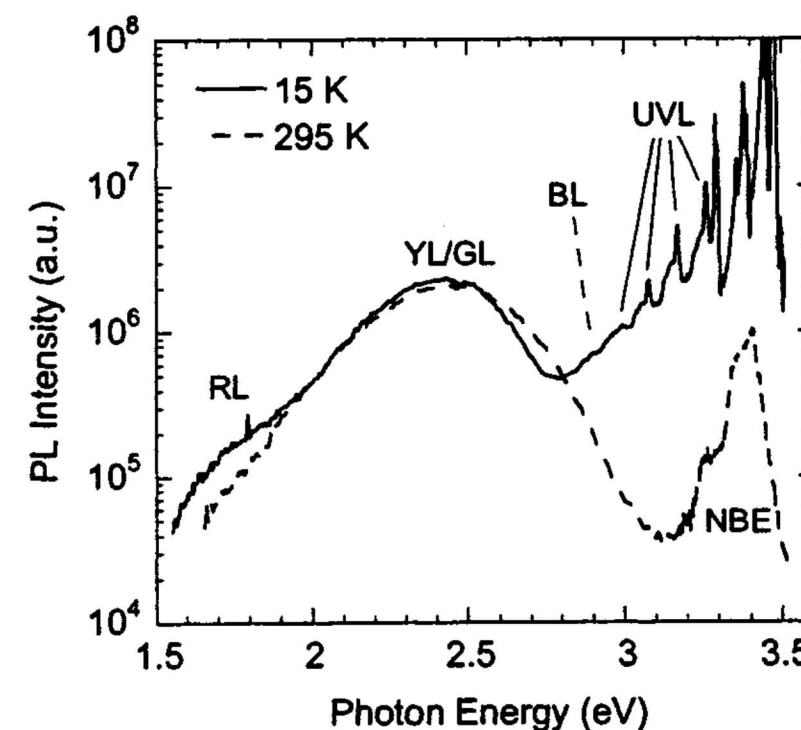
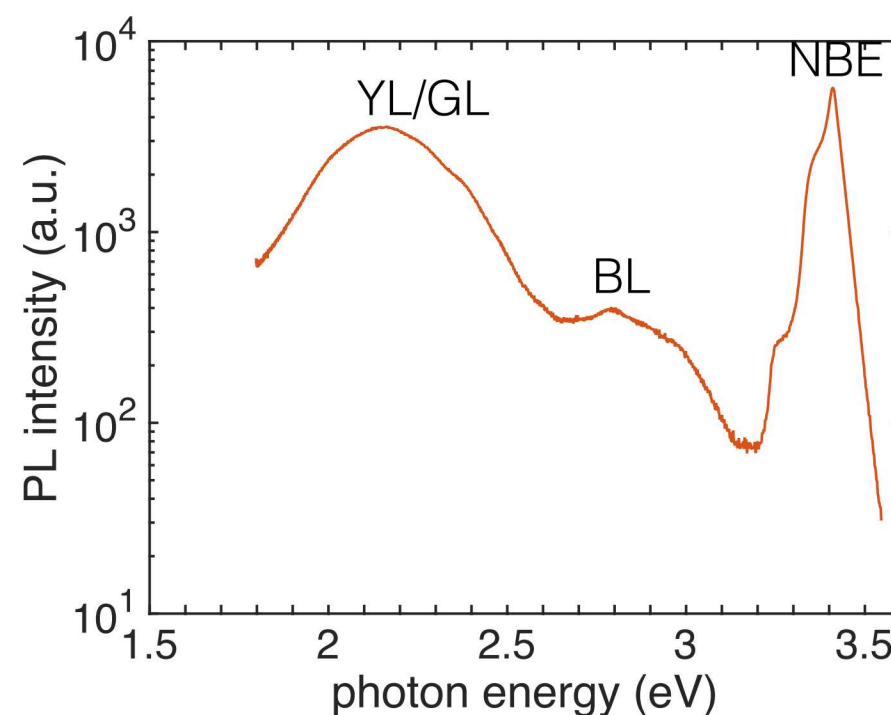
— depth-dependent EBIC
— planar-collector EBIC
— normal-collector EBIC

- Yakimov et al., Appl. Phys. Lett. 90 (2007)
- Yakimov et al., Appl. Phys. Lett. 92 (2008)
- ◇ Polyakov et al., J. Alloy. Comp. 617 (2014)
- ▽ Bandic et al., Sol. State Elec. 44 (2000)
- △ Chernyak et al., Appl. Phys. Lett. 77 (2000)
- ▷ Chernyak et al., Appl. Phys. Lett. 69 (1996)
- ☆ Kumakura et al., Appl. Phys. Lett. 86 (2005)

Sample: Ni Schottky on n-GaN

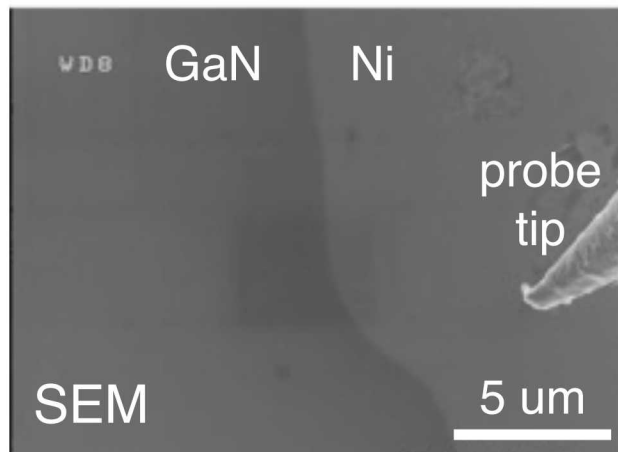
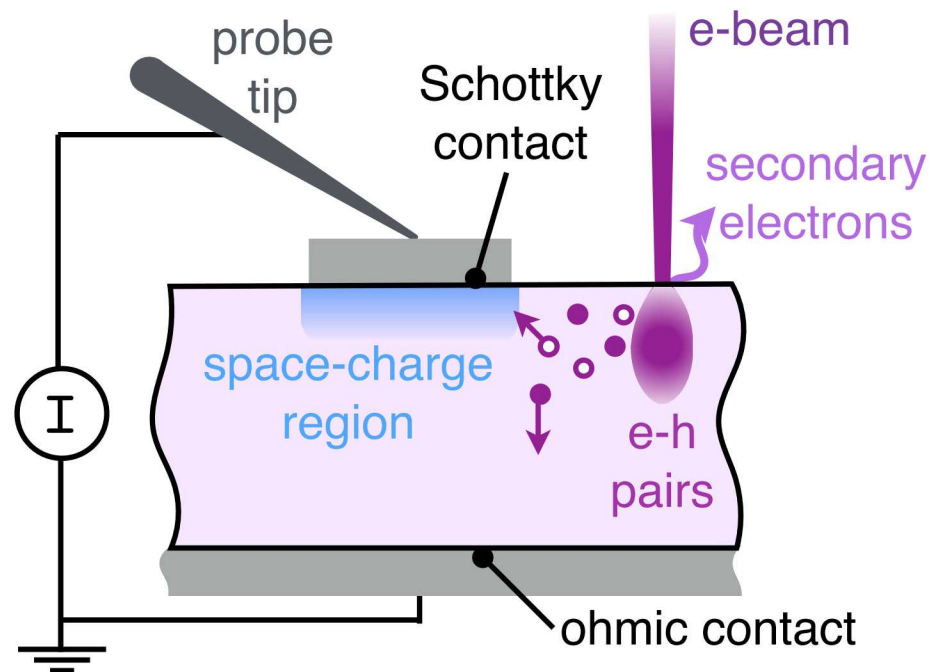


Photoluminescence spectrum comparable to high quality HVPE GaN:



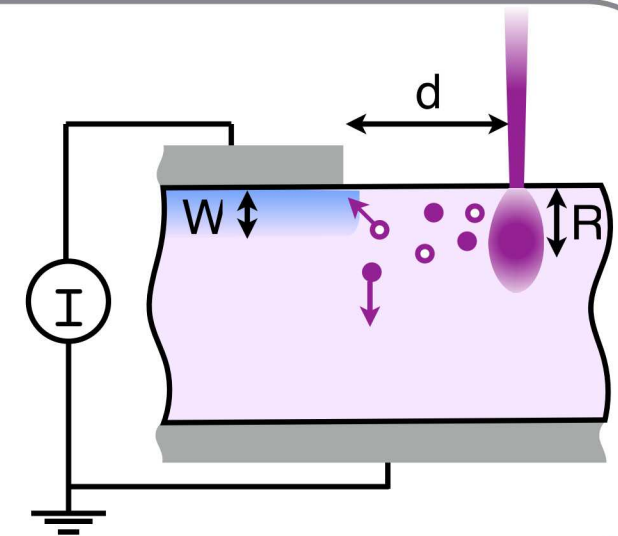
Reshchikov and Morkoc, J. Appl. Phys. 97, (2005)

Electron Beam Induced Current (EBIC)



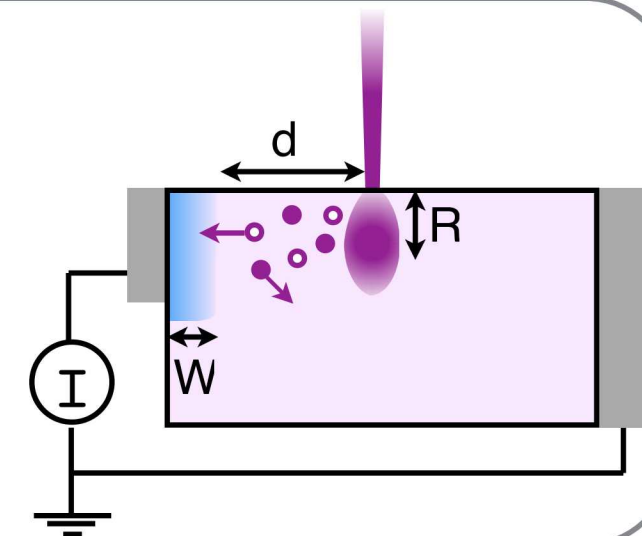
Planar-Collector Configuration

- Vary d
- Straightforward implementation
- Simple model



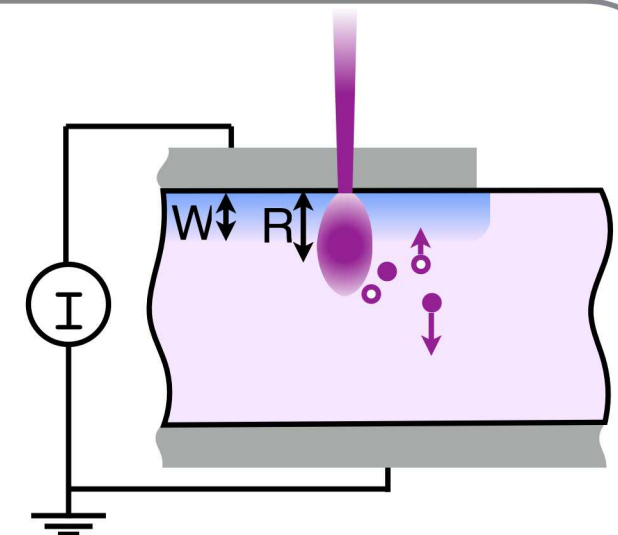
Normal-Collector Configuration

- Vary d
- Challenging implementation
- Simple model

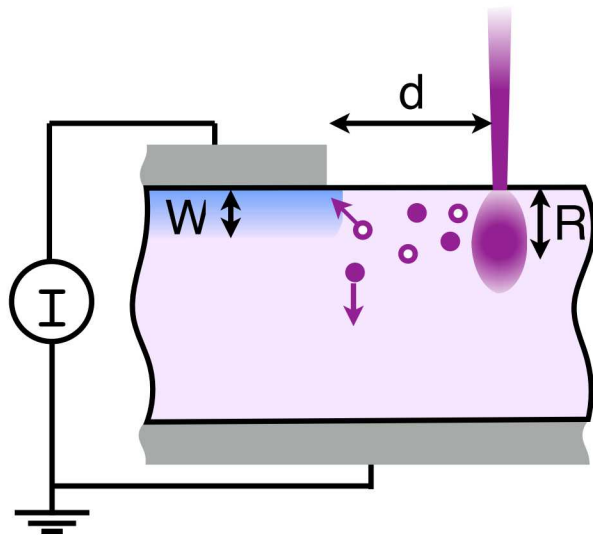


Depth-Dependent Configuration

- Vary R
- Straightforward implementation
- More complex model



Conventional approach: planar-collector EBIC



Simple, commonly used model:

$$I(d) = \exp(-d/L) \cdot d^{-n}$$

$n = 0.5$ for slow surface recombination ($v \rightarrow 0$)

$n = 1.5$ for fast surface recombination ($v \rightarrow \infty$)

Main assumptions:

- $R \gg W$
- $d \gg R$
- $d \gg L$
- Generation at a point source

$d \gg R$ is difficult to satisfy due to signal-to-noise issues

Advantages:

- Straightforward implementation
- Same configuration used for studying defects
- Simple model

Disadvantages:

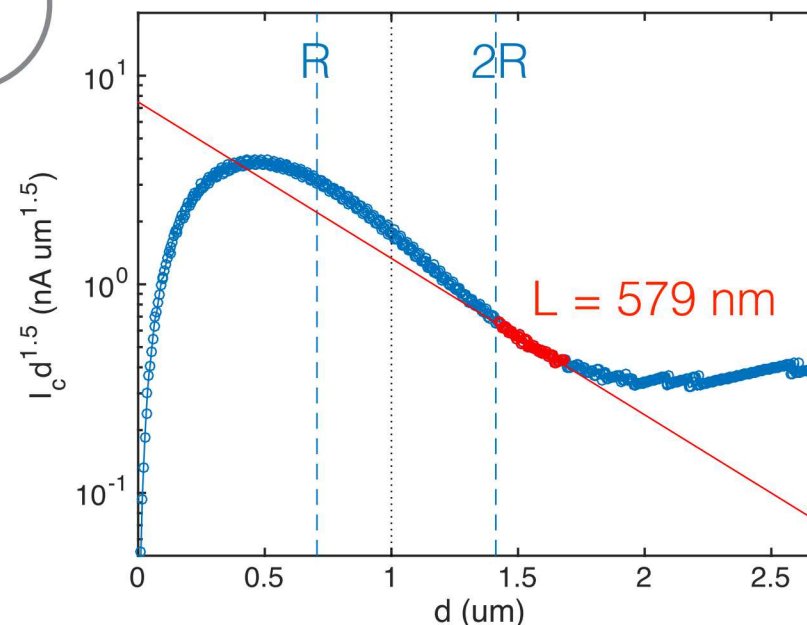
- Model assumptions difficult to satisfy for materials with small L

Typical values for GaN Schottky diodes:

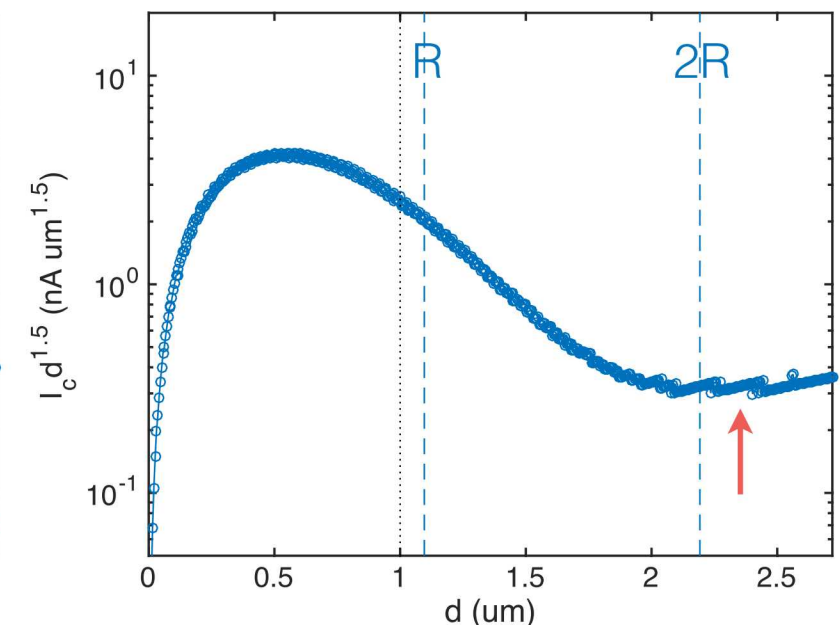
- $W \sim 100$ nm
- 100 nm $< L < 1$ μ m

Yakamov, J. Alloy. and Comp. 627 (2015)

$E_b = 14$ kV



$E_b = 18$ kV

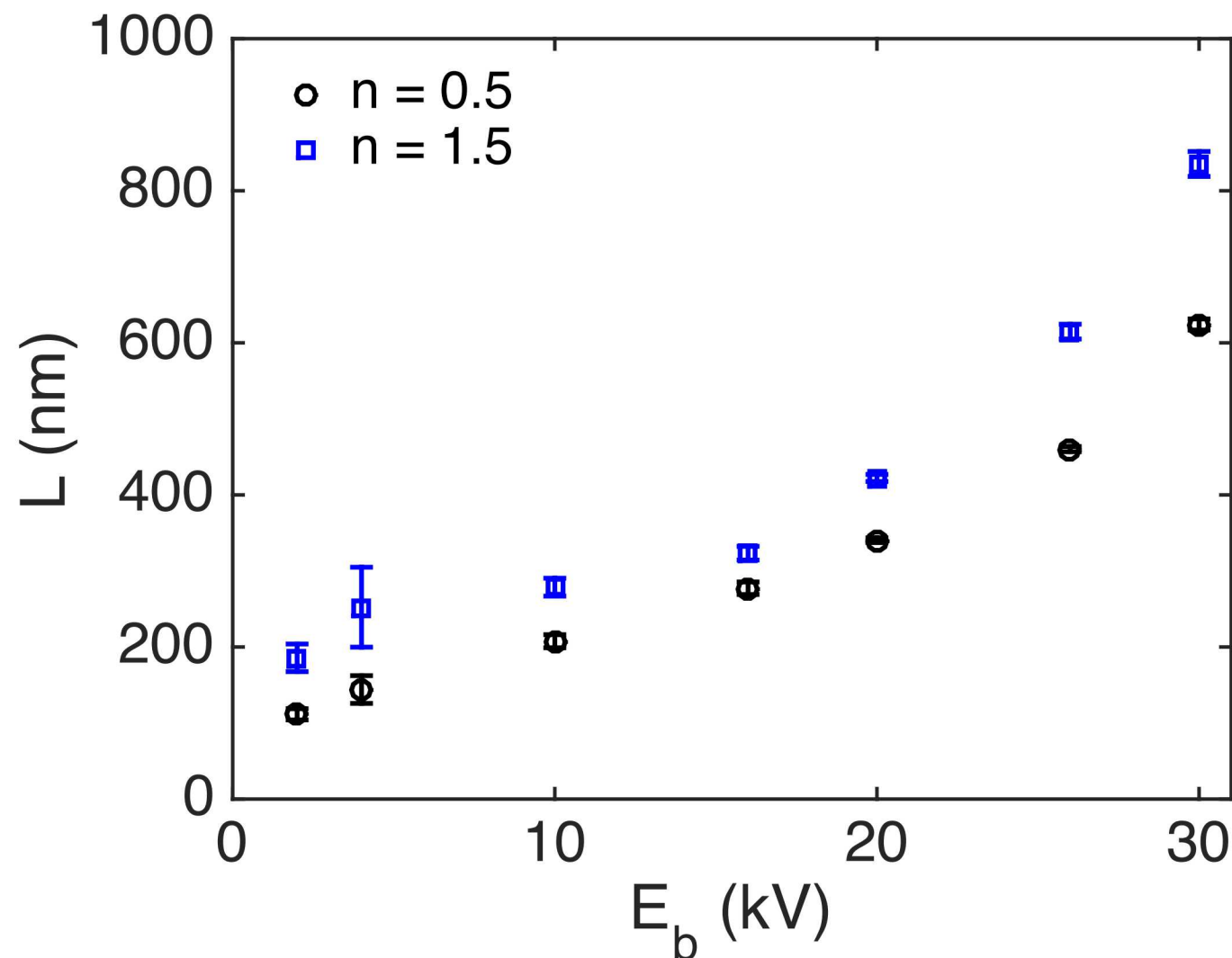


Fitting regardless of model assumptions gives high, inconsistent values for L

$$I(d) = \exp(-d/L) \cdot d^{-n}$$

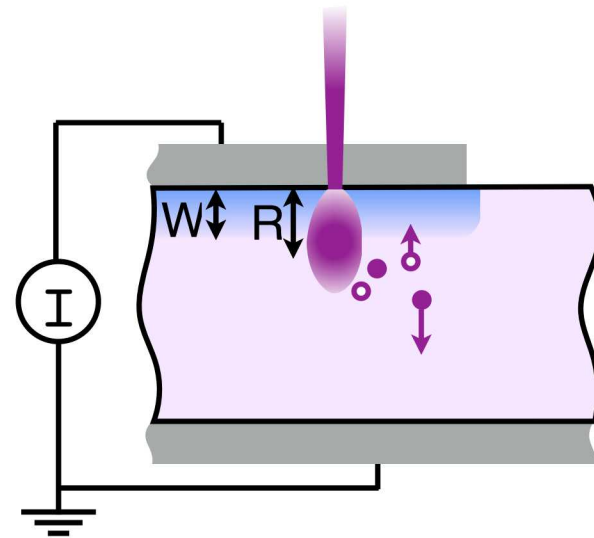
$n = 0.5$ for slow surface recombination ($v \rightarrow 0$)

$n = 1.5$ for fast surface recombination ($v \rightarrow \infty$)



Alternate approach: depth-dependent EBIC

Vary R by changing accelerating voltage, E_b



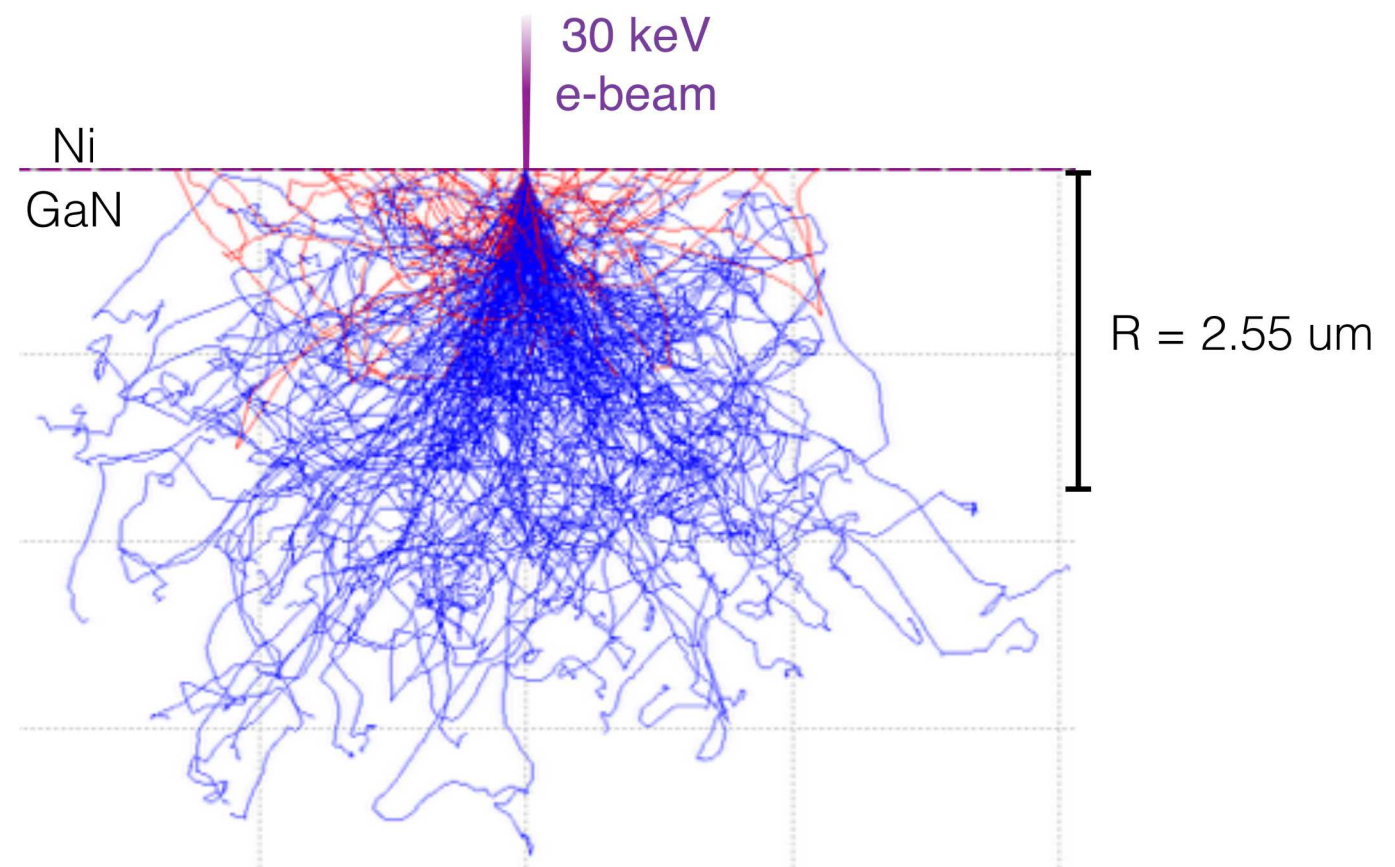
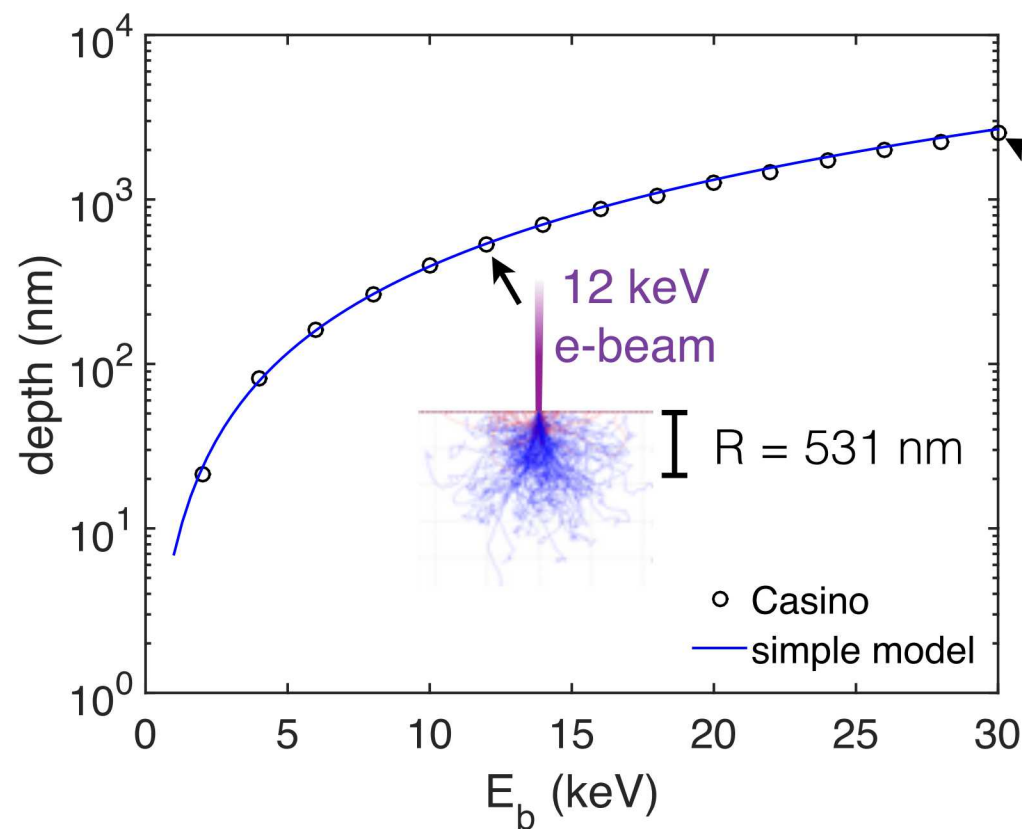
Advantages:

- Straightforward implementation
- Insensitive to surface recombination

Disadvantages:

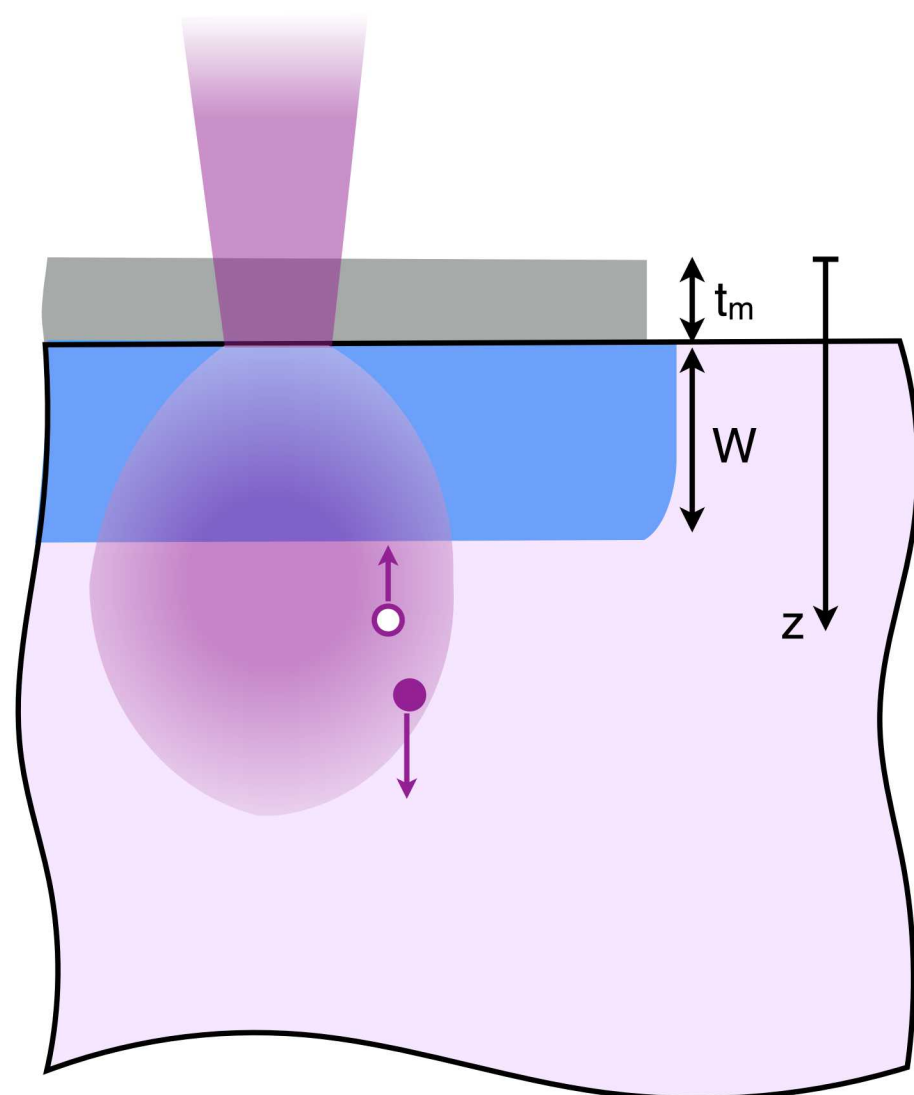
- More complex model

Casino (Monte Carlo) simulation of electron trajectories:



www.gel.usherbrooke.ca/casino/download2.html

Model for collected current in depth-dependent EBIC



collected current

$I_c = e\beta \left\{ \int_{t_m}^W h(z) dz + \int_W^{\infty} h(z) \exp[-(z - W)/L] dz \right\}$

$h(z)$ = depth-dose dependent e-h generation rate

total number of e-h pairs created by e-beam

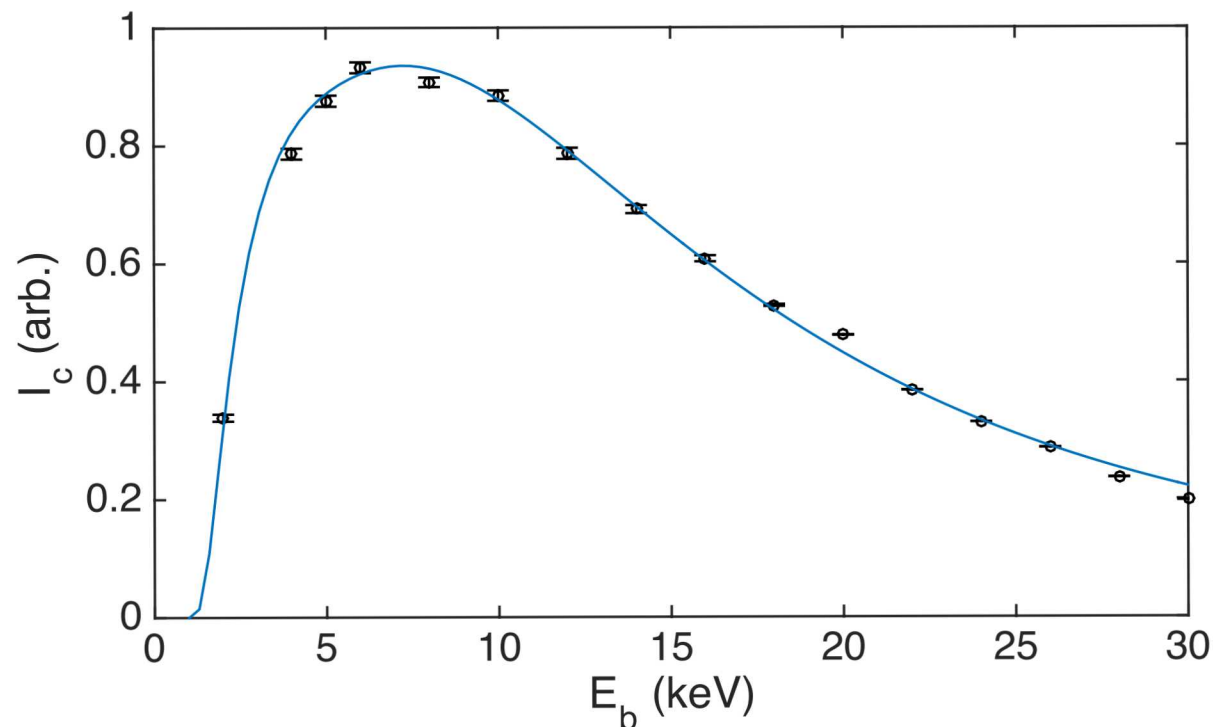
All carriers generated in the space-charge region are collected

Carriers generated in the bulk semiconductor must diffuse to the space-charge region to be collected

Yakamov, J. Alloy. and Comp. 627 (2015)

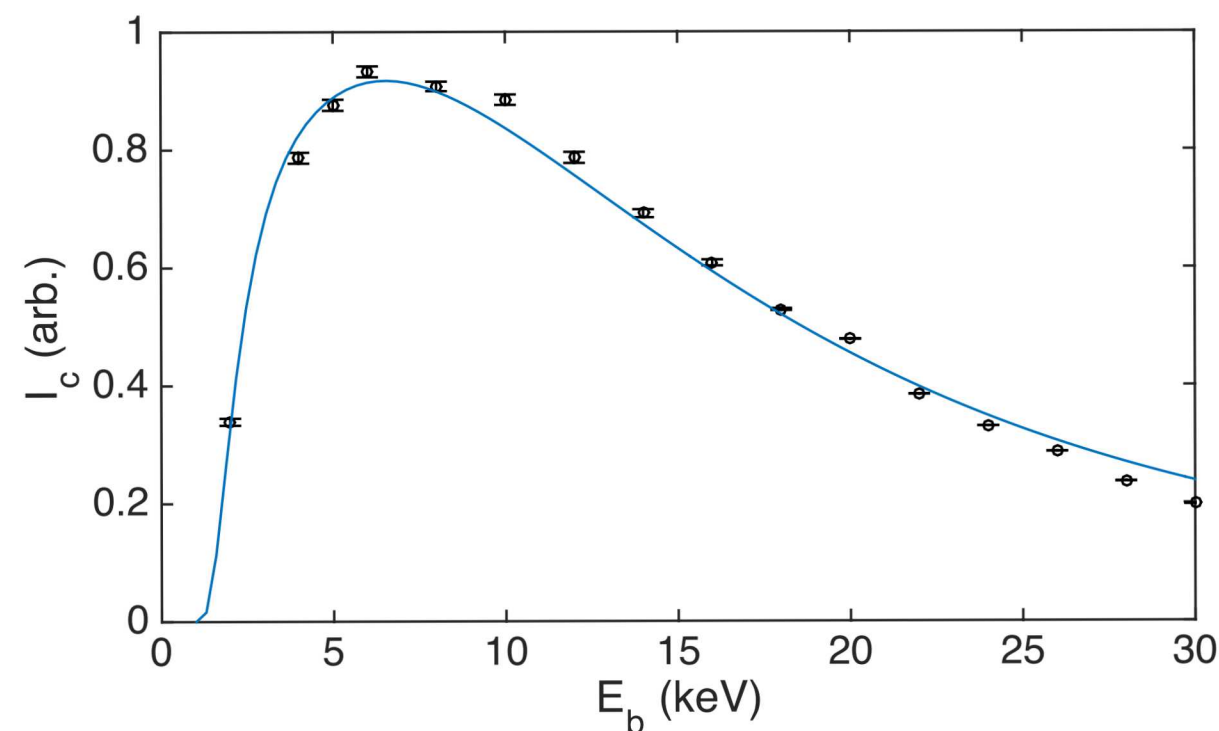
Data and model fitting results

Fitting simultaneously for t_m , W and L :



$t_m = 10.6$ nm
 $W = 153.6$ nm
 $L = 282.4$ nm

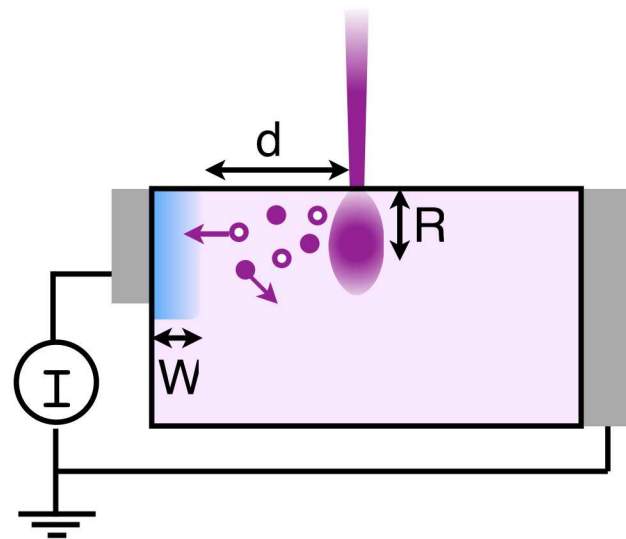
Fitting for t_m and L , assuming $W = 100$ nm:



$t_m = 10.5$ nm
 $L = 366.4$ nm

- Metal thickness target was 8 nm
- Independent measurements found $W \sim 100$ nm

Comparison to normal-collector shows good agreement

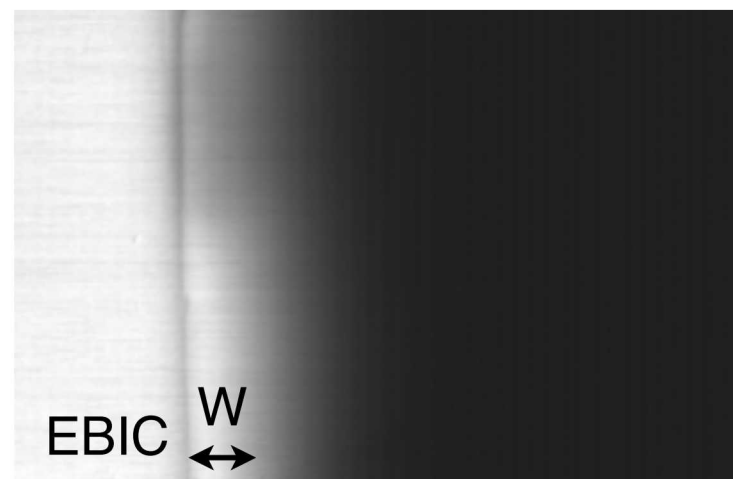
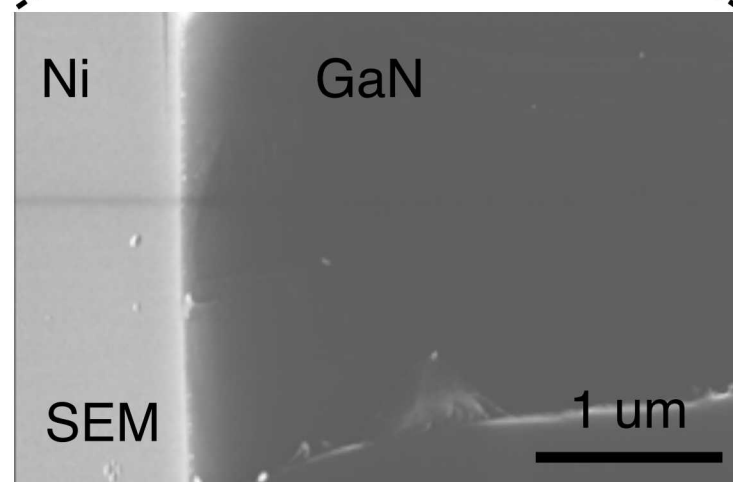
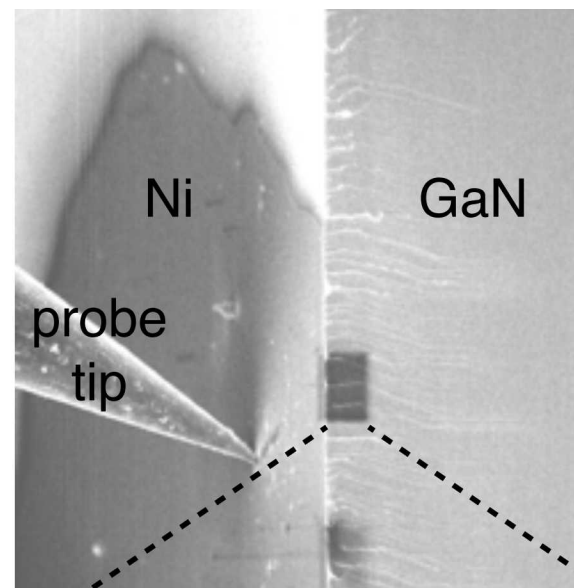


Advantages:

- Simple model

Disadvantages:

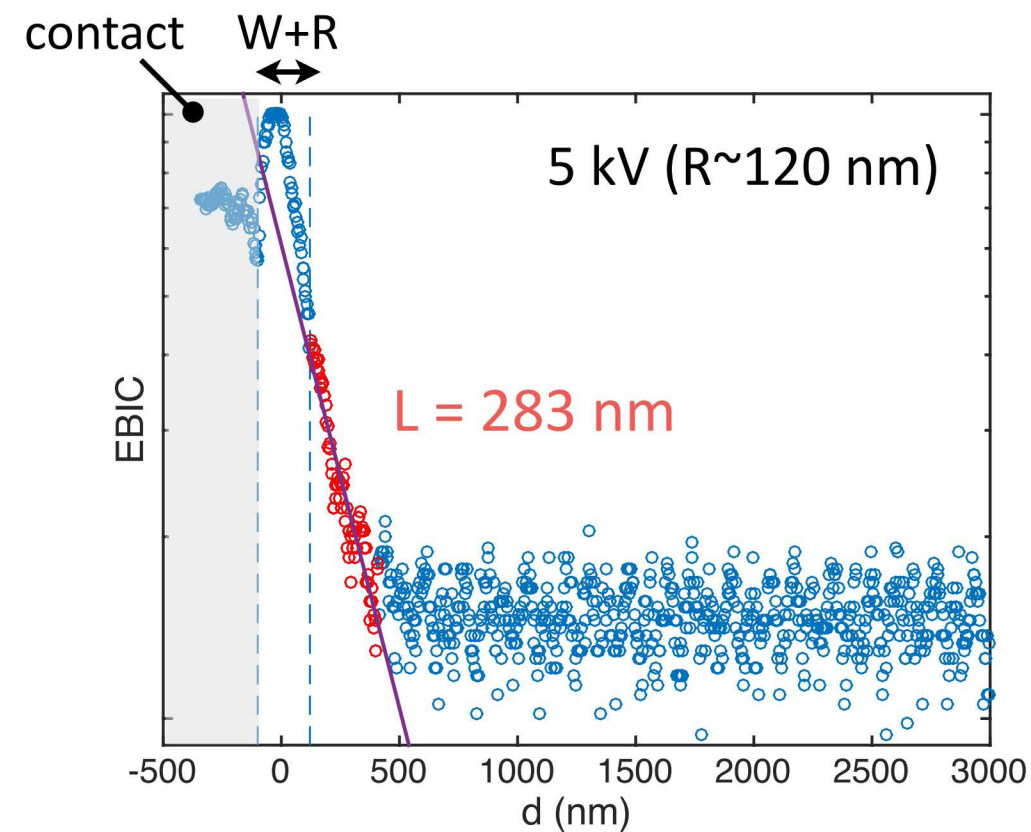
- Challenging implementation



$$I(d) \propto \exp(-d/L)$$

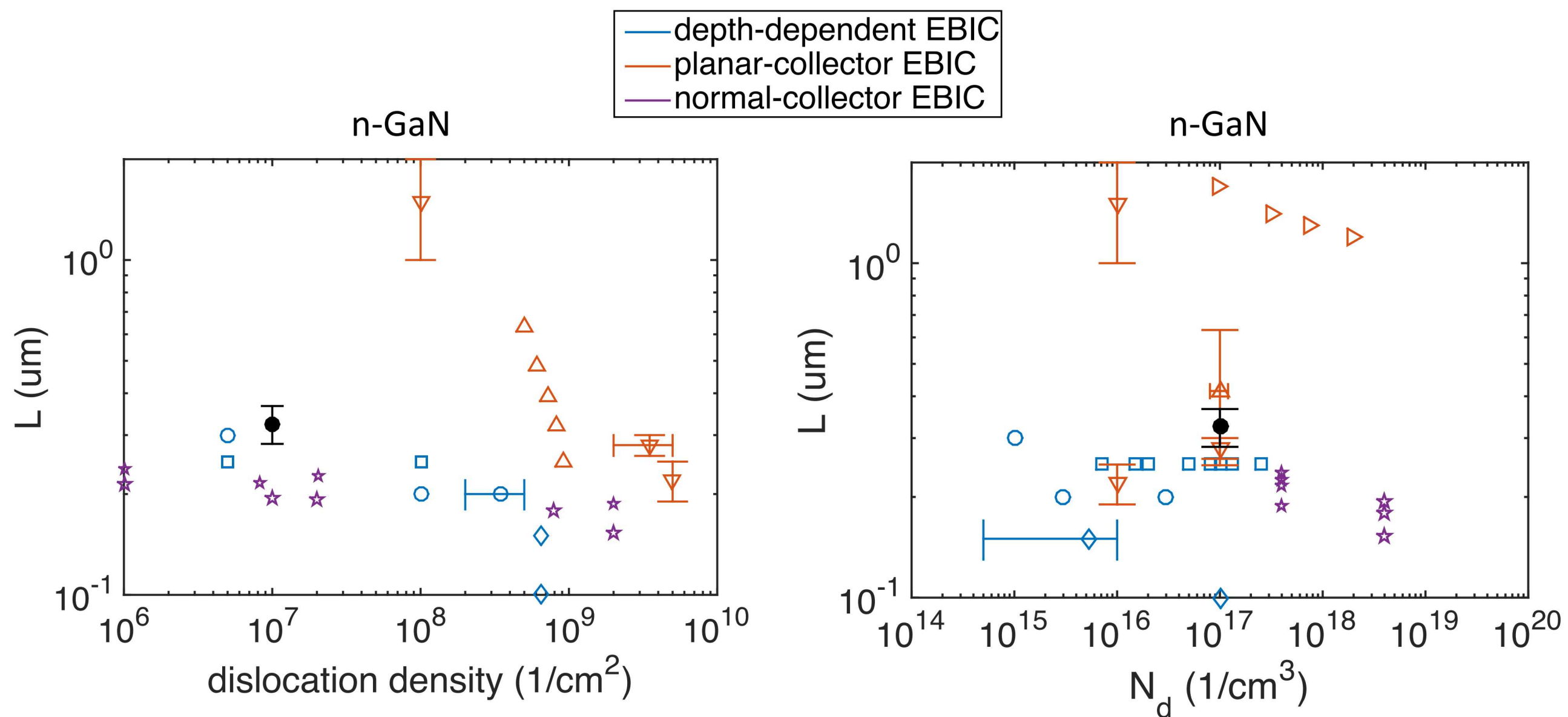
Requires:

- $d > R$
- $R \ll L$
- $R/L < 4$
- Negligible surface recombination ($v \rightarrow 0$)



Luke et al., J. Appl. Phys. 57 (1985)
Ong et al., Solid-State Elec. 37 (1994)

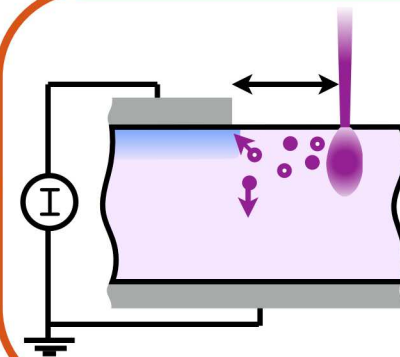
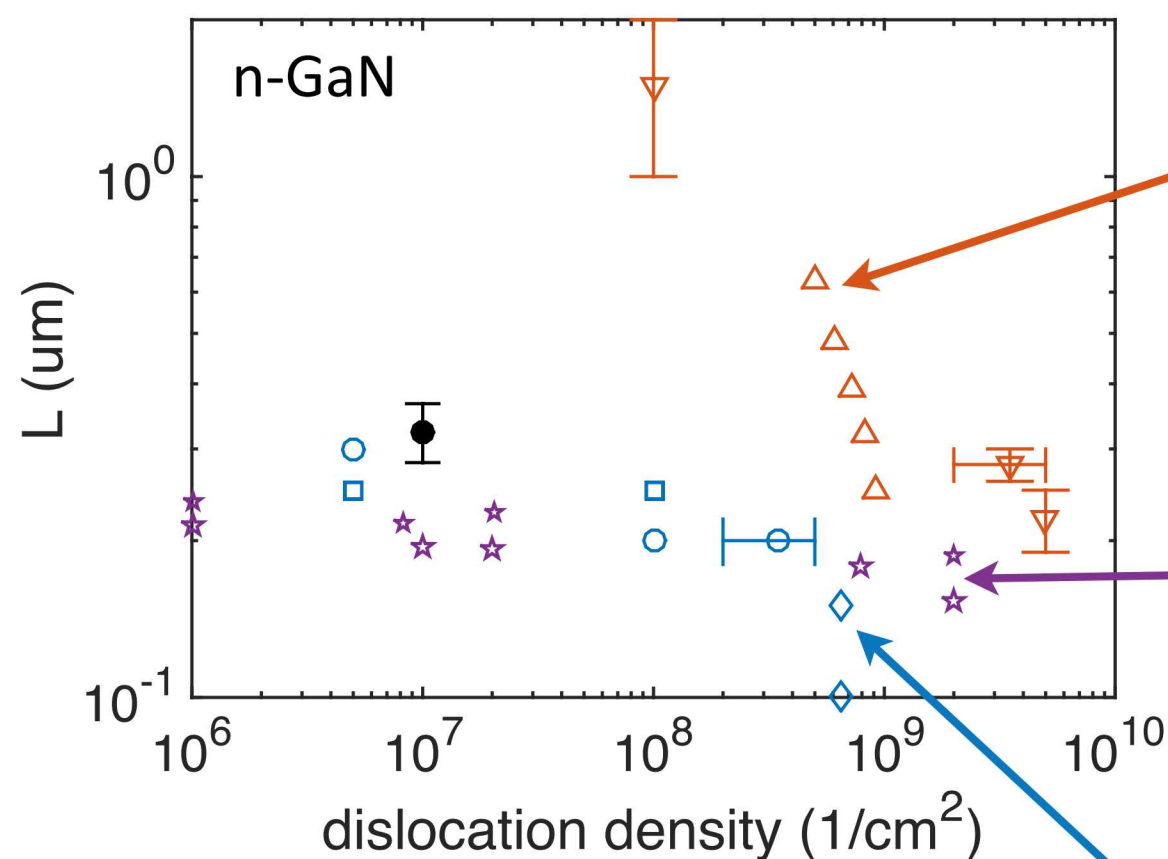
Comparison to literature



- Yakimov et al., Appl. Phys. Lett. 90 (2007)
- Yakimov et al., Appl. Phys. Lett. 92 (2008)
- ◇ Polyakov et al., J. Alloy. Comp. 617 (2014)
- ▽ Bandic et al., Sol. State Elec. 44 (2000)
- △ Chernyak et al., Appl. Phys. Lett. 77 (2000)
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- ☆ Kumakura et al., Appl. Phys. Lett. 86 (2005)

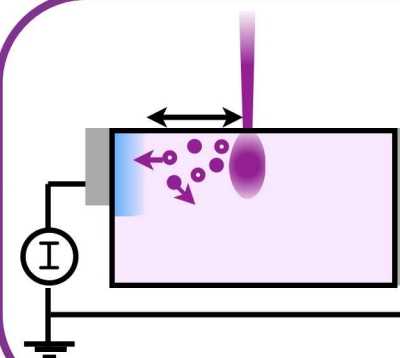
Summary

- We use EBIC to measure the hole diffusion length for high-quality homoepitaxial GaN, and explore three measurement implementations.



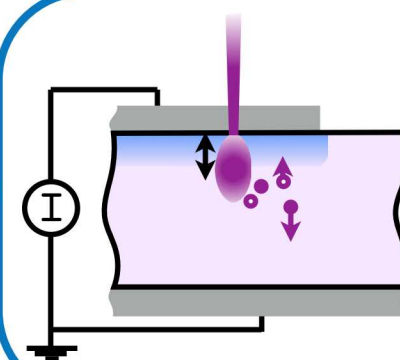
Planar-Collector Configuration

- Use with caution!
- Not a good choice for low L materials.
- Gives high, inconsistent L values.



Normal-Collector Configuration

- Use if possible
- Challenging implementation, but reliable results



Depth-Dependent Configuration

- Best choice
- Straightforward implementation and reliable results that are consistent with the normal-collector configuration